

## SilGrip™ PSA6574 Pressure Sensitive Adhesive

### SilGrip\* PSA6574 Pressure Sensitive Adhesive

#### Description

PSA6574 silicone pressure sensitive adhesive is a toluene solution of phenyl based polysiloxane gum and resin. It is supplied at 55 percent silicone solids and may be further diluted with aromatic, aliphatic or chlorinated solvents. PSA6574 may be blended with SR545 resin dispersion to obtain specific performance properties. PSA6574 adhesive has been found useful in coating of film and fabric substrates for manufacturing industrial pressure sensitive tapes, label stock for extremely high and low temperature applications and transfer tapes. It may be an excellent choice for tapes used in plasma/flame spray applications due to its superior thermal stability.

#### Key Features and Benefits

- Wide temperature range performance, maintains good shear and tack properties at intermittent temperatures up to 500°F
- Adhesion to a wide variety of surfaces including low energy surfaces (silicones, fluoropolymers, polyolefines)
- Resistance to moisture, weathering (ozone, sunlight), chemical (acids, alkalis, oils) and biological (fungus) attack
- Minimum silicone residue on applied surfaces

#### Typical Physical Properties

| Property           | Value |
|--------------------|-------|
| Silicone Solids, % | 55    |

|   |                        |
|---|------------------------|
| Specific Gravity  | 0.98                   |
| Density, lbs/gal  | 8.3                    |
| Viscosity @ 25° (77°F ), cps<br>(Brookfield RVF, #5 spindle, 4 rpm) | 17,000                 |
| Color   | Light Straw            |
| Flash Point, PMCC, ° C (° F)  | 11 (52)                |
| Solvent   | Toluene, VM& P Naphtha |

**TYPICAL CURED ADHESIVE PROPERTIES**

|   |      |
|---|------|
| • Peel Adhesion <sup>(1)</sup> , g/inch   | 2700 |
| • Tack <sup>(2)</sup> , g/cm <sup>2</sup> | 1420 |

(1) 2 mil dry adhesive thickness, 1mil polyester film, uncatalyzed, curing cycle: 10 min air dry, 90 sec at 177°C

(2) Polyken Tack Tester, 1000g weight, 1sec dwell time, 1 cm/sec draw speed, 2 mil dry adhesive thickness, 1mil polyester film, uncatalyzed, curing cycle: 10 min air dry, 90 sec at 177°C

The properties of a cured silicone adhesive are affected by several factors such as type and amount of catalyst, cure cycle, adhesive thickness and backing type and thickness. Higher benzoyl peroxide catalyst concentration will increase cohesive strength of the adhesive and improve shear strength, but it will reduce its adhesive strength resulting in lower tack and peel values.

**Patent Status**

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**Product Safety, Handling and Storage**

The warranty period is 6 months from date of shipment from Momentive Performance Materials if stored in the original unopened container at 25°C (77°F).

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## **Processing Recommendations**

### **Application**

PSA6574 silicone adhesive is supplied at a viscosity suitable for conventional tape coating equipment. If necessary, it may be thinned with toluene, xylene or other compatible solvents. After the adhesive is applied to the backing, it is exposed to a two step process: solvent removal and curing.

### **Solvent Removal**

To achieve optimum adhesive properties, it is essential to optimize the drying step of the process in order to assure that the solvent is removed from the adhesive film before the curing step of the process starts. Improper drying will result in residual solvent entrapment within the adhesive. If the adhesive is then exposed to temperatures higher than 93.5 ° C (200 ° F), decomposing peroxide catalyst can cause crosslinking reaction between solvent and adhesive through methyl groups on siloxane chains and on solvent molecules and adversely affect the properties of the adhesive. Typical temperature range for the drying step of the process is 83 ° C (180 ° F) to 90 ° C (194 ° F). A typical drying cycle is 2 minutes at 90 ° C (194 ° F).

### **Curing Process**

Once the solvent is removed from the adhesive film, the peroxide cure should be initiated by exposure to heat. A typical curing cycle is 2 minutes at 165 ° C (329 ° F). Longer exposure time and higher temperature, up to 204 ° C (400 ° F), can be used without adverse effects. The exact conditions required to achieve a complete cure will depend on oven length and efficiency, peroxide type and type of substrate used, and should be established during experimental trials on the machine.

### **Catalysts**

High purity, 98% benzoyl peroxide <sup>(3)</sup> in the quantity of 1 to 3% based on silicone solids, has been found to give the most consistent results in curing of silicone pressure sensitive adhesives. In applications requiring low temperature cure, 2,4-dichlorobenzoyl peroxide, which is activated at 132 ° C (270 ° F), can be used. It should be noted that 2,4-dichlorobenzoyl peroxide may generate polychlorinated biphenyls during the curing process. Please refer to Code of Federal Regulations, title 40, part 761 regarding incidental PCB byproducts if 2,4- dichlorobenzoyl peroxide is utilized.

The peroxide should be dispersed in solvent before it is mixed with the adhesive. Thorough mixing of the peroxide and adhesive to achieve homogeneous dispersion is essential for consistency of finished product.

(3) Available from: Elf Atochem North America, Inc.,

## Priming

In certain applications, the anchorage of the adhesive to the backing may be insufficient and the coating of a primer prior to the adhesive coating may be required.

A typical formulation for a primer may be found in Table1 below. The formulation may need to be adjusted depending on required bath life, coating equipment and backing material. The primer may be coated by direct gravure, wire wound rod or other coating technique suitable for solvent based coatings, and must be cured prior to adhesive application. The curing conditions will depend on equipment capabilities, substrate type and formulation used and should be established during experimental trials on the machine.

### Table1. Typical Primer <sup>(4)</sup> Formulation

| Component              | Parts by Weight |
|------------------------|-----------------|
| SS4195A-D1             | 13.3            |
| SS4191B                | 0.3             |
| SS4192c                | 0.5             |
| SS4259c                | 0.5             |
| Solvent <sup>(5)</sup> | 85.4            |

(4) Refer to document #CDS5511, SS4195-D1 Primer for Phenyl Based Silicone Pressure Sensitive Adhesives, for more information

(5) Typical solvents: toluene, heptane, toluene/heptane mixtures

### Limitations

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